



Material Content Data Sheet



Sales Product Name		SMBTA 56 E6327		Issued		29. August 2013		
MA#		MA000049625						
Package		PG-SOT23-3-4		Weight*		9.08 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		14	
	noble metal	gold	7440-57-5	0.013	0.14		1415	
	inorganic material	silicon	7440-21-3	0.110	1.21	1.35	12086	13515
leadframe	non noble metal	chromium	7440-47-3	0.009	0.10		996	
	inorganic material	silicon	7440-21-3	0.001	0.01		66	
	non noble metal	titanium	7440-32-6	0.003	0.03		332	
	non noble metal	copper	7440-50-8	3.001	33.05	33.19	330500	331894
wire	noble metal	gold	7440-57-5	0.018	0.20	0.20	1991	1991
encapsulation	organic material	carbon black	1333-86-4	0.091	1.00		10008	
	inorganic material	antimonytrioxide	1309-64-4	0.136	1.50		15012	
	plastics	brominated resin	-	0.170	1.88		18765	
	plastics	epoxy resin	-	1.420	15.64		156373	
	inorganic material	silicondioxide	60676-86-0	3.862	42.53	62.55	425335	625493
leadfinish	non noble metal	tin	7440-31-5	0.136	1.50	1.50	15025	15025
plating	noble metal	silver	7440-22-4	0.110	1.21	1.21	12082	12082
*deviation	< 10%					Sum in total:	100,00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com